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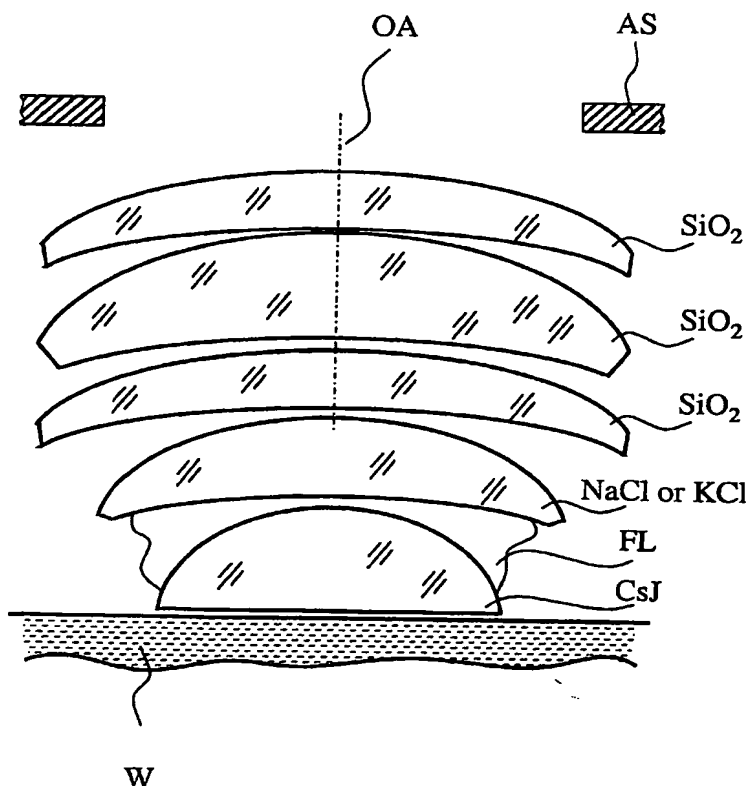
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(54) Title: **MICROLITHOGRAPHY PROJECTION OBJECTIVE WITH CRYSTAL LENSES**



(57) Abstract: Very high aperture microlithography projection objectives operating at the wavelengths of 248 nm, 193 nm and also 157 nm, suitable for optical immersion or near-field operation with aperture values that can exceed 1.4 are made feasible with crystalline lenses and crystalline end plates P of NaCl, KCl, KJ, RbJ, CsJ, and MgO, YAG with refractive indices up to and above 2.0. These crystalline lenses and end plates are placed between the system aperture stop AS and the wafer W, preferably as the last lenses on the image side of the objective.

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Microlithography Projection Objective with Crystal Lens

The invention relates to a microlithography projection objective with at least one crystal lens, wherein the
5 objective is designed in particular for a high numerical aperture and with immersion or optical near field.

From publications such as

10 Bruce W. Smith et al. Optical Microlithography XVII
Proc. SPIE 5377 (2004), p 273 -284;

Bruce W. Smith et al. Optical Microlithography XVI,
Proc. SPIE 5040 (2003), p 679 -689;

15

John H. Burnett et al. "High Index Materials for 193 nm
and 157 nm Immersion lithography"
Int'l Symp. on Immersion & 157 nm Lithography, Vancouver
8/2/04 (NIST/ Corning Tropel)

20

and patent applications such as
WO2004/019 128 A2,
or, commonly owned with this application:
US 6,717,722 B,

25 US Ser. No. 10/734,623 filed 15 Dec. 2003,
US Ser. No. 60/530,623 filed 19 Dec. 2003,
US Ser. No. 60/530,978 filed 22 Dec. 2003,
US Ser. No. 60/544,967 filed 13 Feb. 2004,
US Ser. No. 60/568,006 filed 04 May 2004,
30 US Ser. No. 60/592,208 filed 29 July 2004,
US Ser. No. 60/591,775 filed 27 July 2004,
US Ser. No. 60/612,823 filed 24 Sept 2004,
DE 10 2004 051 730.4 filed 22 Oct. 2004

some information about this art can be gathered.

Of these, e. g. WO 2004/019 128 A2, US 10/734,623,
5 US 60/592,208, US 60/591,775 and US 60/612,823 show
objective designs which can be optimized by and combined
~~with the use of materials and teachings according to this~~
application.

10 Suitable immersion liquids are inter alia described in US
60/568,006 or DE 10 2004 051 730.4.

PCT application entitled "Microlithography Projection
Objective with Crystal Elements", inventor Karl-Heinz
15 Schuster, filed on December 10, 2004, internal reference
04213 P PCT, assigned to the same assignee teaches the
case of certain non-cubic crystals in this context. Each
can be combined with this invention.

20 All cited documents are incorporated into this application
by reference in their entirety.

Their citation in no way constitutes any declaration on
their relevance for this application, and the list
25 certainly is incomplete and many more publications relate
to this art.

Crystal lenses consisting in particular of calcium
fluoride (fluorspar) or other fluorides have been used
30 until now as a means to achieve a sufficient transmittance
at wavelengths below 200 nm and down to, e.g., 126 nm, and
also to achieve a chromatic compensation by using fluoride
lenses particularly in combination with lens elements of

quartz glass. As a rule, these arrangements involved the use of several crystal lenses in the objective, with diameters exceeding 10 cm and with a combined thickness of the order of 10 cm, where the lenses had to be arranged at
5 different places in the objective, including in particular locations close to the pupil and close to the object.

~~Because of the resulting requirements regarding the~~
homogeneity of the mono-crystals only lenses of calcium fluoride were realized in actual practice.

10

The same material is also known to be suitable for lenses close to a field plane because of its higher radiation resistance associated with a lower degree of compaction compared to quartz glass.

15

To reduce the achievable structure widths in lithography systems, the first approach that always comes to mind is to use shorter wavelengths. However, the shorter the wavelength, the more difficult it becomes to find suitable
20 immersion materials and lens materials with a high refractive index. Attempts have therefore been made to stay with longer wavelengths but find materials that have an even higher refractive index to compensate for the disadvantage of the longer wavelength. For example, in
25 order to obtain the same level of resolution with light of 248 nm as with light of 193 nm, the aperture has to be larger by a factor of 1.285. According to the formula $NA = k_1 \lambda / (\text{structure width})$, i.e., $NA = 0.3 \times 248.338 \text{ nm} / 50 \text{ nm}$, a resolution of 50 nm would require a refractive index of
30 at least 1.49 if a value of 0.3 has been selected for k_1 .

Since quartz glass (fused silica, SiO_2) has a refractive index of 1.506235 at a wavelength of 248 nm, a resolution

of 50 nm for $k_1 = 0.285$ could be achieved with the available standard material SiO_2 . However, the next node at 45 nm is not attainable without a change of material.

5 Consequently, it is an object of the invention to propose lens materials with a particularly high refractive index for lenses in the area near the image plane of an objective of the kind described in generic terms in the introductory paragraph, including suitable protector
10 plates or other elements. If the refractive index is higher than for quartz glass, it is also possible to use materials whose other properties are less ideal, such as calcium fluoride, for individual elements with a thickness of a few millimeters to centimeters.

15

Solutions to the foregoing task are proposed in accordance with the independent claims, with advantageous further developed embodiments being proposed in accordance with the subordinate claims and in accordance with the
20 description in its entirety.

In accordance with the invention, a material has been found which has a higher refractive index and can meet all other requirements for lithography applications. As a
25 prerequisite, the material needs to be sufficiently isotropic. However, an intrinsic birefringence in the deep ultraviolet range near the absorption edge has to be tolerated. As a rule, the further away the absorption edge, the smaller are the values of the intrinsic
30 birefringence. A particularly advantageous selection is achieved if the intrinsic birefringence crosses the zero level at the wavelength being used for the lithography application.

For the 45 nm node and a wavelength of 248.338 nm, sodium chloride (NaCl) was found to be suitable, which at this wavelength has a refractive index of 1.657766. Its
5 intrinsic birefringence is small enough that no compensation is necessary. As it is sufficient to make ~~the last optical element or individual ones among the last~~ elements in the objective from this material, all of the other elements can be of quartz glass, which is preferred.
10 However, one could also use, e.g., calcium fluoride.

The invention will be further explained hereinafter with reference to the drawings, wherein Figures 1 to 8 schematically illustrate sections through the lenses near
15 the image plane of a projection objective according to the invention, including the immersion area and the wafer or another object being exposed to the projection.

The following symbols are used consistently in the
20 drawings:

AS = aperture stop / system aperture
P = protector plate / protective element
I = immersion
25 W = wafer, or the object to be exposed in the image plane
FL = fluid configured as a fluid lens
OA = optical axis

30 Figure 1 schematically illustrates the last lenses on the image side of a microlithography projection objective according to the invention with an immersion fluid I, for example 25% D₃PO₄ in D₂O ($n_{248} \approx 1.66$), a monocrystalline

last lens of NaCl, with a plane-parallel thin protector plate P or a protective layer placed in between.

- For values of $k_1 = 0.285$, $\lambda = 248.338$ nm and a maximum incidence angle of 71.8° from the normal direction, one finds a minimum refractive index of 1.6556, a condition ~~that is met by sodium chloride with a refractive index of 1.657766.~~ Monocrystalline NaCl is not hygroscopic in air, in contrast to commercially available kitchen salt which contains impurities of MgCl and therefore attracts water. It should be clear that the work operations on NaCl in the production process have to be free of water, because NaCl dissolves in liquid water. However, the appropriate working techniques have been known for decades.
- Otherwise, the lenses can be coated with vapor-deposited layers and worked on with ion beams. Inside the objective, which is normally flushed with helium or nitrogen, moisture is in any event of no concern.
- To achieve the 32 nm node at 248 nm requires a large step in the refractive index. One finds that the refractive index needs to come up to slightly more than 2.0. At the same time, it is still necessary to obtain a satisfactory transmittance. According to the invention, the material proposed to meet these requirements is potassium iodide KI with a refractive index of $n=2.0523$ at 248.338 nm.

Similar to NaCl, potassium iodide is water-soluble but advantageously isotropic. Other representatives of the alkali group in the form of iodides are likewise suitable, including NaI, RbI, CsI.

Since the primary use of iodides is in the infrared range, no raw materials of extreme purity have so far been used to grow crystals for the far ultraviolet range. The transmittance edge for CsI, a material of the highest refractive index, is reported as 227 nm, so that the transmittance values obtained for NaI, Ki, RbI tend to be even more favorable.

The highest index of refraction is obtained with CsI as it has the highest atomic weight in the alkali group. Already at the present time monocrystalline CsI is grown and commercially distributed for infrared applications. As a special precaution, it needs to be noted that the relative humidity of the ambient air around this crystal may not exceed 35%.

Figure 2 shows the end portion of a refractive or catadioptric objective with an aperture of more than 2.0. The wafer W is for example in the optical near field, with a distance of 20 nm. To show an example of a fluid lens FL, a fluid from the group of highly refractive substances that are also known as immersion fluids is arranged between the last two lenses on the image side of the objective.

As the iodides of the alkali group are very soft and therefore mechanically delicate, it is recommended to use appropriate protective measures. Proposed is a protector plate of MgO, which has an extremely high refractive index.

For applications at 248 nm and other wavelengths, magnesium oxide MgO has to be produced in crystalline form

- with the requisite purity. In the form of a thin element, it is sufficiently transparent. The crystalline oxide material is isotropic and has a coefficient of linear thermal expansion of $14 \times 10^{-6}/K$, while CsI for example has
- 5 a linear expansion coefficient of $54.9 \times 10^{-6}/K$. In order to safely join these materials by wringing, it is ~~necessary to overlay the iodide with an adhesive layer of~~ a highly refractive material, for example hafnium oxide over CsI.
- 10
- Instead of making the lenses of alkali iodide and protecting them with MgO plates, it is of course also possible to use MgO itself for the one or more last elements if a crystal material of suitable transmittance
- 15 and homogeneity is used. Given that MgO has very good chemical and mechanical properties and is a most highly refractive material with a refractive index over 2.0, it is suitable for the wavelength of 248 nm, if the crystal quality is appropriately optimized.
- 20 Instructive comments on this may be found in the paper by John H. Burnett et al. "High Index Materials for 193 nm and 157 nm Immersion Lithography", Intl. Symp. On Immersion + 157 nm Lithography, Vancouver, 2 Aug 2004.
- 25 Figure 3 represents an example of a refractive or catadioptric projection objective in which the system aperture stop or the conjugate plane of the system aperture stop that is closest to the image plane is followed by a lens group in which the last lens and in
- 30 this case also the next to last lens on the image side of the objective are lenses of monocrystalline magnesium oxide.

Within the context of the periodic system of elements, MgO has a unique position.

The oxides of the first group, i.e., of the alkali group, are very unstable chemically and therefore not usable. Among the oxides of the second group, the alkaline earth group, ~~the oxide of the lightest element is BeO.~~ While the latter has a good transmittance, it has a wurzite structure and is therefore birefringent. The further oxides MgO, CaO, SrO, BaO have the crystal structure of NaCl and are optically isotropic.

However, the transmittance of CaO, SrO, BaO at 248 nm is inadequate. The lightest element of the third group, boron, forms the compound B₂O₃, which is strongly hygroscopic and, by absorbing water, disintegrates into boric acid. The next heavier element, aluminum, forms sapphire crystals which are strongly birefringent. Gallium trioxide (Ga₂O₃) in both of its modifications (corundum type / monoclinic) is birefringent. Indium trioxide In₂O₃ lacks transmittance already for 248 nm and is likewise birefringent.

Magnesium oxide has the further advantage of an excellent chemical stability in contact with many immersion fluids I, which necessarily should likewise have a very high index of refraction at 248 nm. With a system that works in the optical near field, it is important to pay attention to the need for frequent cleaning. Using MgO in the last optical element of the system is advantageous also because of its exceptional hardness and ease of cleaning.

With no immediate need to push up the refractive index at the 45 nm node, it also makes sense to protect an NaCl lens with a thin MgO plate.

- 5 It is clear that objectives with aperture values of this magnitude have to be designed with extreme asphericities. ~~It is proposed that the high-refractive elements presented~~ above be likewise designed with aspheric surface curvatures.

10

- In order to prevent the MgO element from heating up, it is important that the MgO crystal be produced from base material components of the highest purity. A certain amount of absorption can be tolerated as long as MgO
15 serves only as a protector plate that is overlaid on another optical material, because with a small thickness of for example 1.0 mm, the absorption volume, and consequently the heat generation, will remain small. If entire lenses are made of MgO, one should aim for a
20 crystal of high purity.

- The 193 nm wavelength, while not yet representing the majority of applications, is an established working wavelength and therefore, as a natural consequence,
25 attractive for a further reduction of the structure widths through the use of very large NA values.

- The highest refractive indices presently used in the end-positioned elements which consist of CaF₂ or SiO₂ are:
30 $n = 1.501436$ for CaF₂ at 193.304 nm
 $n = 1.560289$ for SiO₂ at 193.304 nm

Chromatic compensation materials with a higher refractive index and a higher dispersion than CaF_2 are known, e.g., from U.S. Patent 6,683,729 B1 (inventor Schuster) and from the aforementioned paper by Burnett et al., including
5 among others the following:

SrF_2 for 193.304 nm $n = 1.510219$

~~BaF_2 for 193.304 nm $n = 1.567043$~~

Thus, an objective with a large refractive lens element of
10 BaF_2 in the end position stands up better to radiation than amorphous SiO_2 , but the refractive index is not significantly increased in comparison to SiO_2 .

In order to safely reach the 32 nm node with the 193 nm
15 wavelength, one needs a sufficiently high refractive index of the last lens element. For example with $k_1 = 0.265$ a refractive index of 1.658 is needed, or with $k_1 = 0.285$ a refractive index of 1.812. The photoresists for 193 already reach values as high as $n = 1.75$ in the best case.

20 A material has now been found which at 193 nm is sufficiently homogeneous and isotropic in the sense of the cubic crystal structure: Potassium chloride KCl has a very good transmittance at 193 nm and more than satisfies
25 the requirement of a refractive index of 1.685. In fact, the refractive index of KCl is 1.756255 at 193 nm. Given that the resists already reach indices up to 1.75, there is a possible application for a system where the light passes from the last lens to the resist on a wafer by
30 means of the optical near field without immersion.

Figure 4 schematically illustrates the part of a projection objective that extends from the aperture stop

plane AS (system aperture plane or a conjugate plane of the system aperture plane) closest to the image field, equipped with KCl lenses according to the invention in near-field distance from a resist / wafer W.

5

Many applications, also at the 32 nm node, can be realized ~~and manufactured more easily with k_1 factors not quite as~~ small as mentioned above. A second optical material has been found which meets the requirements of isotropy and
10 transmittance at 193 nm. In addition, the refractive index is even higher.

Sodium chloride NaCl has a refractive index of 1.829085 at a wavelength of 193 nm. As a result, the k_1 -factor for
15 193 nm and for the 22 nm node can be raised again to 0.287, if one sets a maximum geometric incidence angle of 71.8°. However, with NaCl the absorption edge is slightly closer to 193 nm. Consequently, the contributions to the intrinsic birefringence are larger with NaCl than with
20 KCl.

Therefore, special attention has to be paid to the compensation of the intrinsic birefringence. To compensate the intrinsic birefringence in the case of
25 NaCl, it is proposed to join curved surfaces of NaCl lenses of different crystallographic orientation by wringing (see Figure 4).

It is likewise proposed to perform a compensation by using
30 two different materials. Among other possibilities, this also includes combinations such as NaCl/MgO and NaCl/CaF₂.

Figure 5 shows an end group of a projection objective configured in this manner with a lens member made of two wrung-together KCl lens elements and as the closing member on the image side two wrung-together monocrystalline NaCl lens elements. The crystallographic orientations of the lens elements are in each case rotated relative to each other for the compensation of birefringence.

Another example is illustrated in Figure 6, where an individual KCl crystal lens is arranged in combination with an NaCl lens member of two wrung-together elements.

The coefficient of expansion is $36.6 \cdot 10^{-6} \text{ K}^{-1}$ for KCl, and $39.8 \cdot 10^{-6} \text{ K}^{-1}$ for NaCl. It therefore makes sense and is feasible to join the two different materials by wringing. This is shown schematically in Figure 7.

Because of its large index of refraction, NaCl should be used as the last optical element of positive refractive power. However, since larger amounts of intrinsic birefringence are present in this case, the KCl lens combines a greater refractive power with smaller intrinsic birefringence and favorable transmittance, so that the intrinsic birefringence can be compensated better and the heating of the last double lens can be kept smaller due to the reduced overall amount of absorption.

Consequently, the invention is also directed to the use of the proposed materials in 248 nm or 193 nm lithography applications; to the use of the optical near field or immersion simultaneously with the proposed materials; to the compensation of the intrinsic birefringence in NaCl at 193 nm; to the compensation of the intrinsic birefringence

associated with KCl lenses; to mixed combinations in which KCl and NaCl lens elements are wrung together; to refractive indices larger than 1.75 or larger than 1.82 in lenses; to the use of chlorine compounds as a crystal
5 material for the wavelength of 193 nm; to the location where the materials are used within the objective, i.e., ~~after the aperture stop or after a conjugate location of~~ the aperture stop and before the image plane; to an angle of incidence on the lens surface of at least 60° and
10 preferably larger than 70° in lenses of the proposed materials; and to the use of p-polarized light in these materials.

The term "lens" as used herein refers to a refractive
15 optical element of only one material, also often referred to as lens component.

Notwithstanding any of the concepts proposed herein, this optical element can still be coated, in particular with
20 anti-reflex coatings and protective coatings against chemical and physical factors such as being attacked by aggressive chemicals, being dissolved by water or other solvents (moisture protection coating), or against scratching.

25 A further crystal material that has been found suitable for the lens elements of a lithography objective is YAG (yttrium aluminum granate). Its chemical formula is $Y_3Al_5O_{12}$.

30 As a result of the yttrium content in the crystal molecules, the refractive index of YAG is higher than in MgO. In particular for 248 nm, YAG has a good

transmittance. As YAG has been used for many years as a material to grow high-quality crystals for lasers, and with the need to continuously improve these lasers, YAG has in the meantime been developed much farther than for
5 example MgO or spinel MgAl_2O_4 .

~~Besides spinel with an absorption edge at 160 nm and MgO~~
with an absorption edge at 165 nm, YAG is another material that is still sufficiently transmissive at 193 nm.

10

Based on the higher index of refraction one can estimate that an absorption edge in YAG lies at about 175 nm. This makes YAG suitable as a material for lithographic projection systems for wavelengths of 248 nm and 193 nm.

15 YAG is basically isotropic but exhibits intrinsic birefringence at 248 nm and in particular at 193 nm, as is also known to occur in CaF_2 and has been described above for chloride crystals. To compensate this birefringence, it is proposed on the one hand to place at least 2 YAG-
20 lenses close up to the wafer or on the other hand to use a combination of YAG with MgO, or YAG with spinel, or all of the three kinds of crystals.

Figure 8 illustrates the foregoing concept schematically
25 in an example.

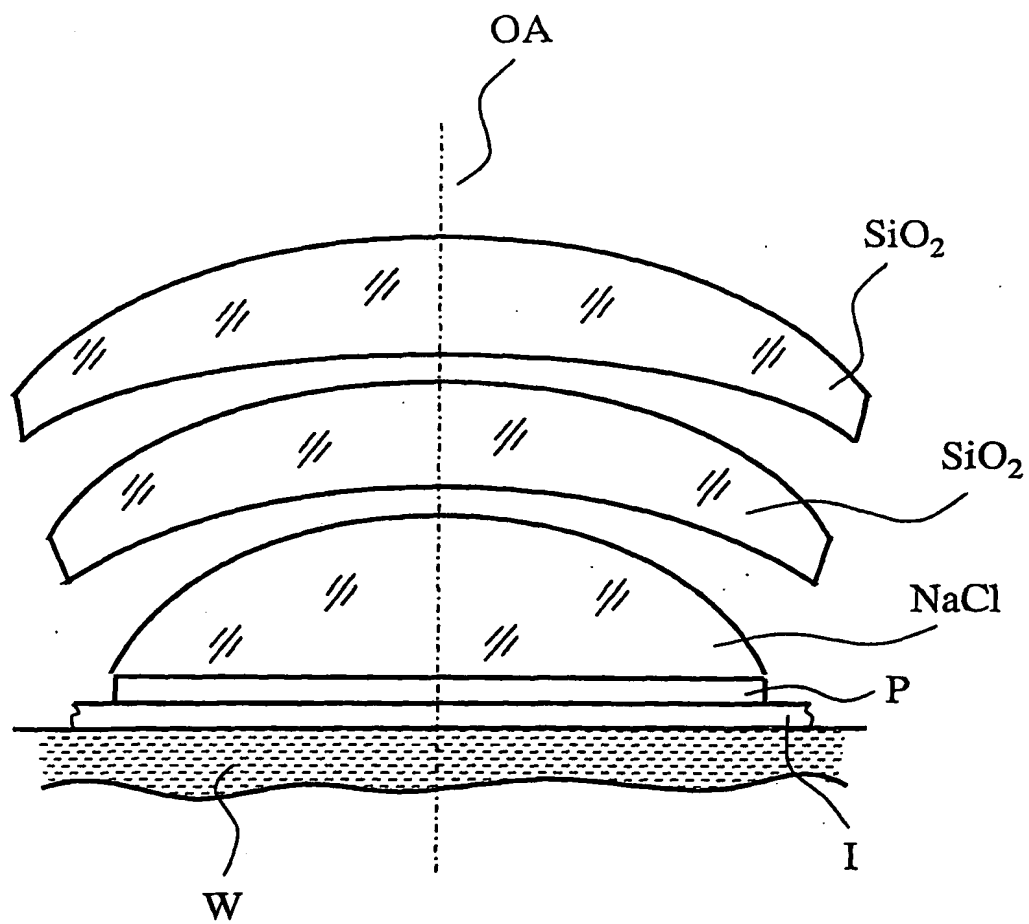
Patent Claims

1. Microlithography projection objective with a numerical aperture on the image side equal to or larger than
5 1.0, containing at least one lens of a crystal material from the group that comprises NaCl, KCl, KJ, NaJ, ~~RbJ, CsJ, MgO, MgAl₂O₄ and Y₃Al₅O₃~~
2. Microlithography projection objective according to
10 claim 1, characterized in that the last curved lens on the image side consists of one of the crystal materials named.
3. Microlithography projection objective according to
15 claim 1 or claim 2, characterized in that the numerical aperture on the image side is more than 1.40, preferably more than 1.65, and with special preference more than 2.0.
- 20 4. Microlithography projection objective according to at least one of the preceding claims, characterized in that at least one lens of one of the named crystal materials has a moisture protection coating.
- 25 5. Microlithography projection objective according to at least one of the preceding claims, characterized in that a plurality of lenses consist of one of the crystal materials named, preferably of different ones, and that the index of refraction at an operating
30 wavelength is highest for the lens that is arranged nearest to an image plane of the projection objective.

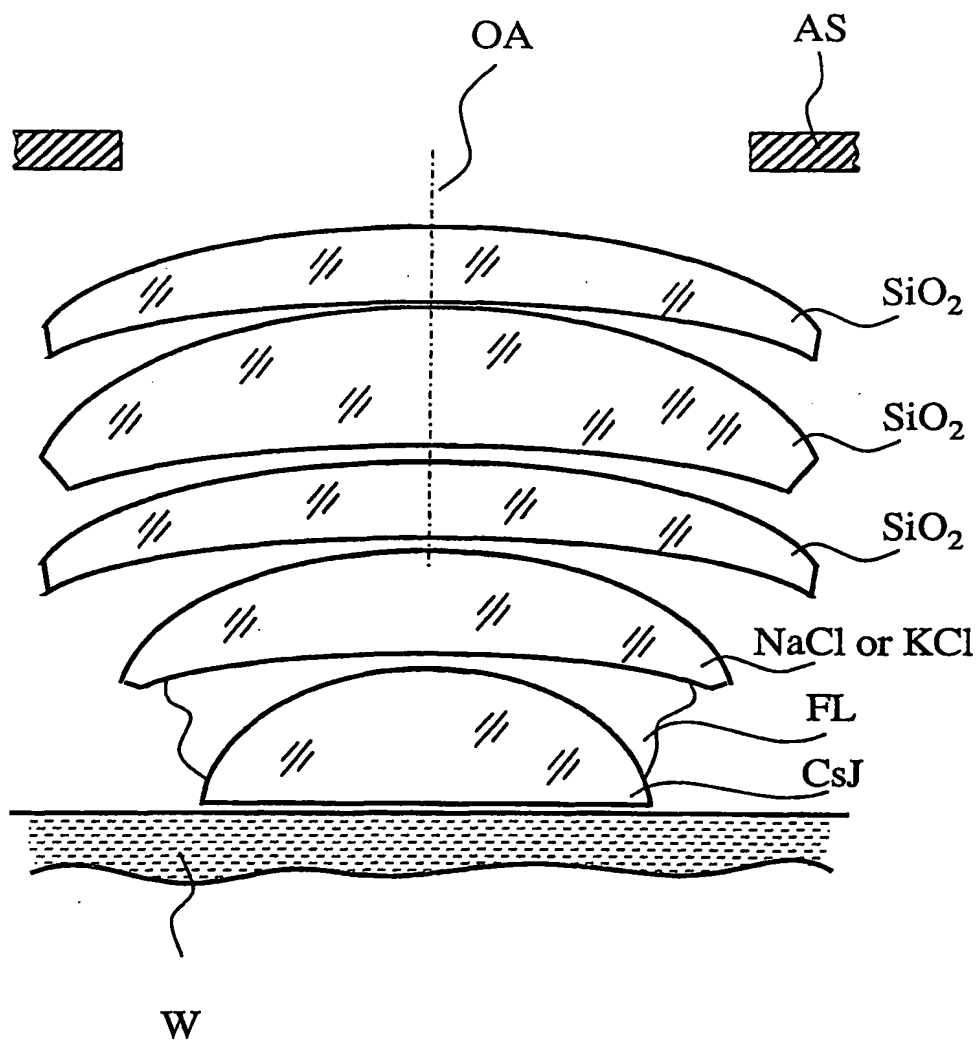
6. Microlithography projection objective according to at least one of the preceding claims, characterized by being configured as an immersion objective.
- 5 7. Microlithography projection objective according to at least one of the preceding claims, characterized by ~~being configured as an optical-near-field-objective.~~
8. Microlithography projection objective according to at least one of the preceding claims, characterized by having an operating wavelength from the group comprising 248 nm, 193 nm and 157 nm.
- 10 9. Microlithography projection objective according to at least one of the preceding claims, characterized in that at least one of the lenses of one of the crystal materials named is composed of at least two lens components that are oriented with different crystallographic orientations.
- 15 20
10. Microlithography projection objective according to at least one of the preceding claims, characterized in that at least one lens is composed of a plurality of components and that at least one of said components consists of a crystal material according to claim 1.
- 25
11. End plate of a microlithography projection objective, consisting of crystalline magnesium oxide which can be overlaid with a coating.
- 30
12. Microlithography projection objective with an end plate according to claim 11, in particular with the features of at least one of the claims 1 to 10.

13. Use of lens components made of crystalline material with a refractive index of more than 1.55, preferably more than 1.6, in an objective of a projection system conforming preferably to one of the preceding claims, characterized in that at least two of said lens components made of different crystalline materials are used in said objective.
- 5
- 10 14. Microlithography projection system with a microlithography projection objective according to at least one of the claims 1 to 10 and 12, or involving the use of lens components according to claim 13.

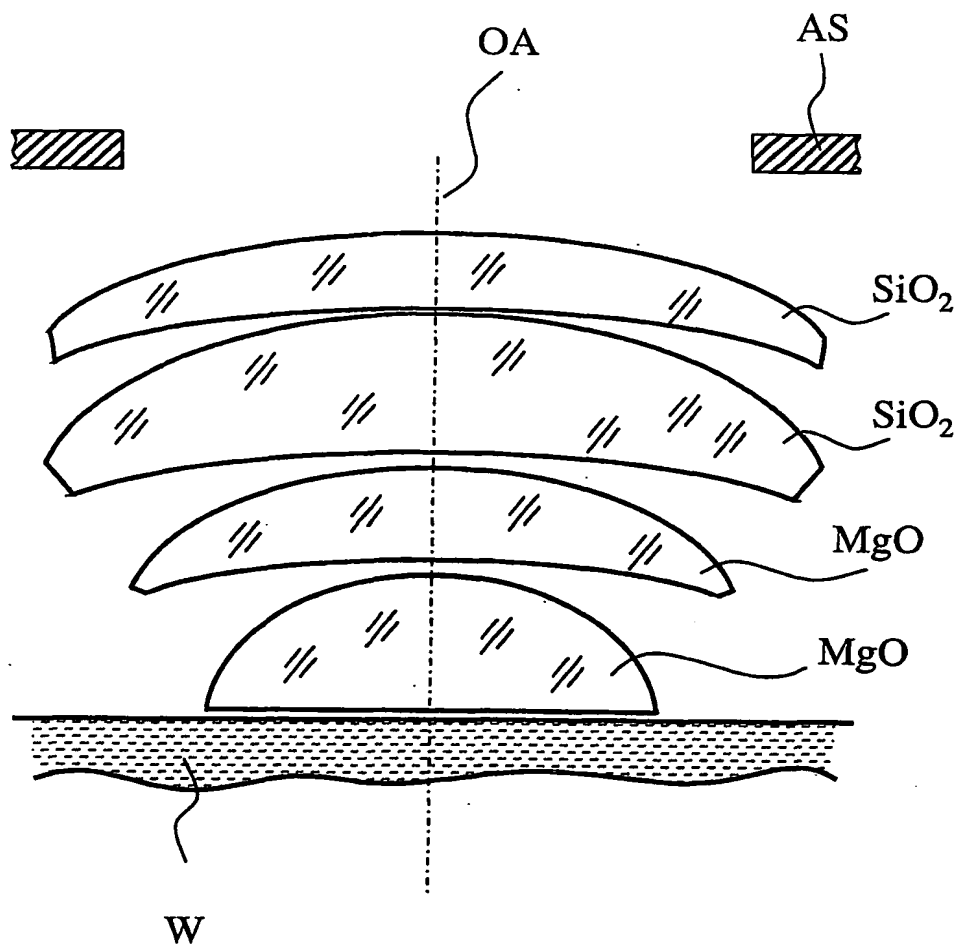
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FIG.1

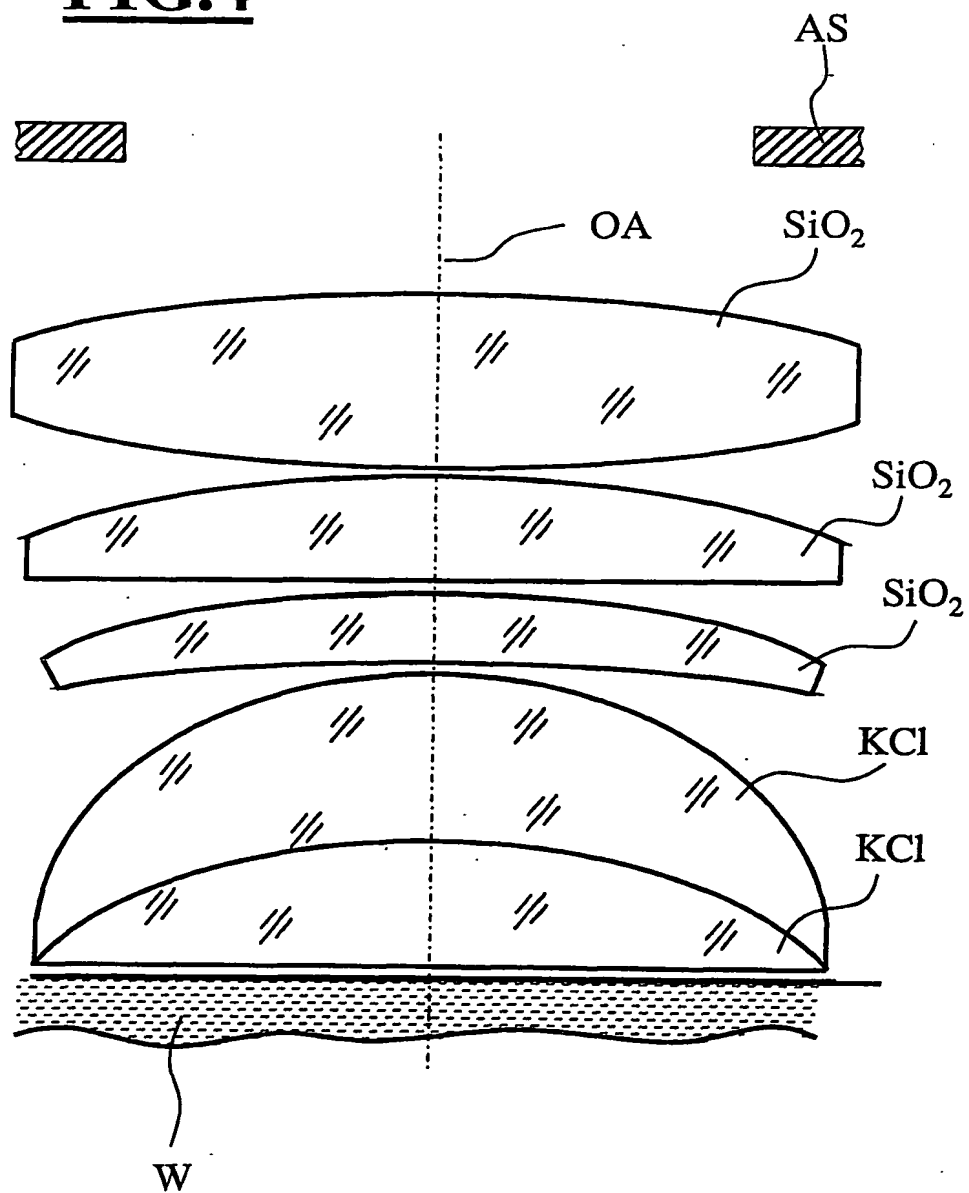
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FIG.2

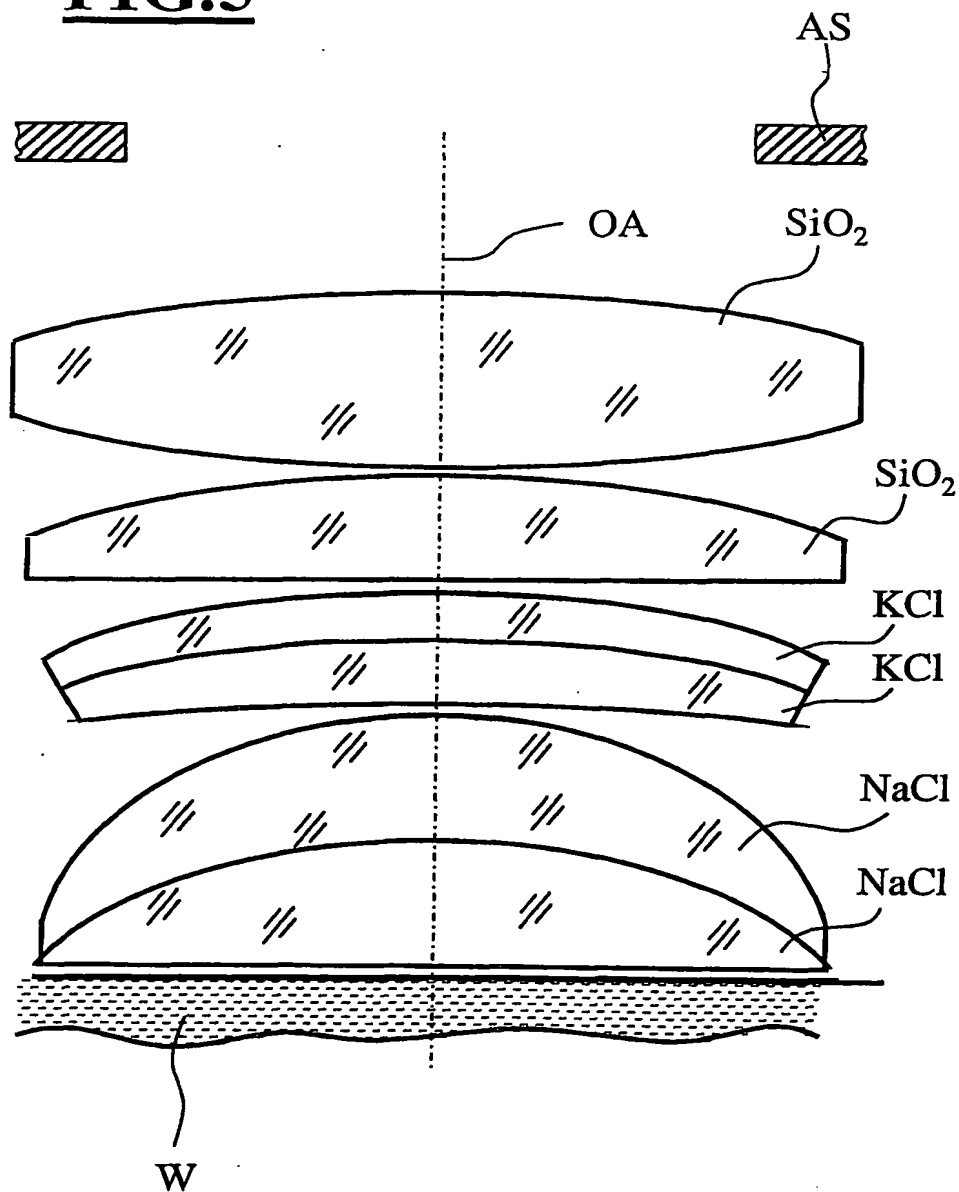
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FIG.3

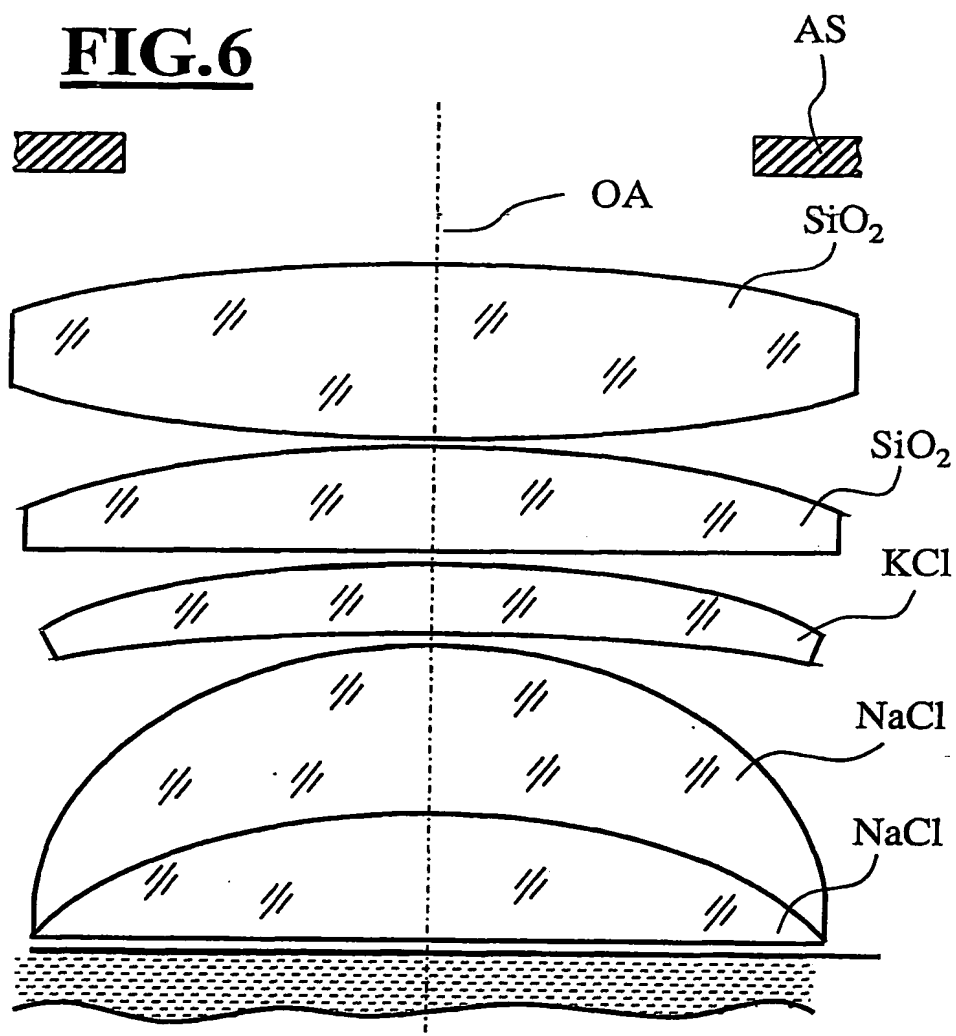
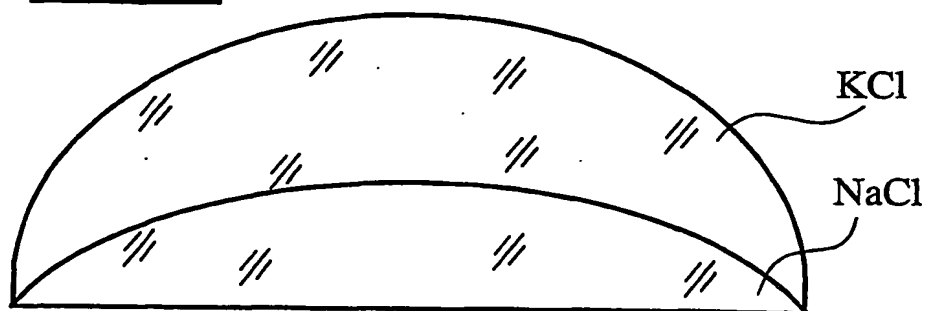
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FIG.4

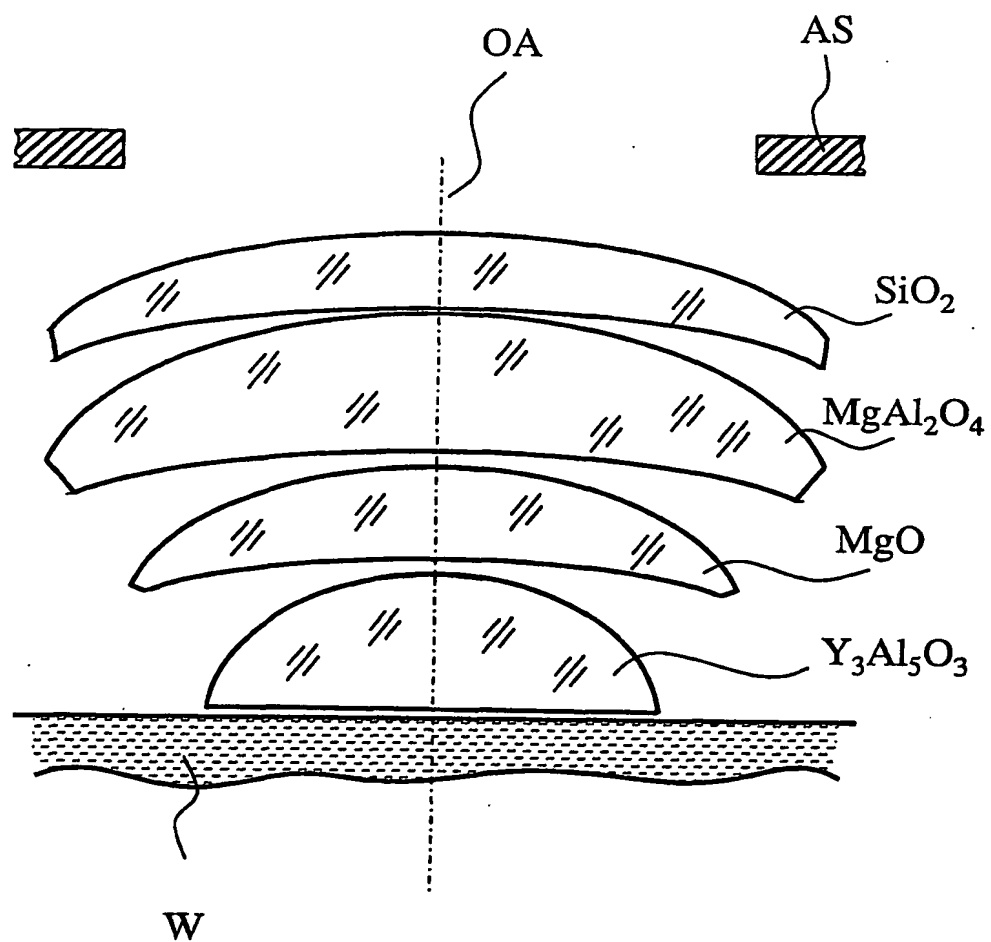
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FIG.5

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FIG.6**FIG.7**

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FIG.8

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30 June 2005 (30.06.2005)

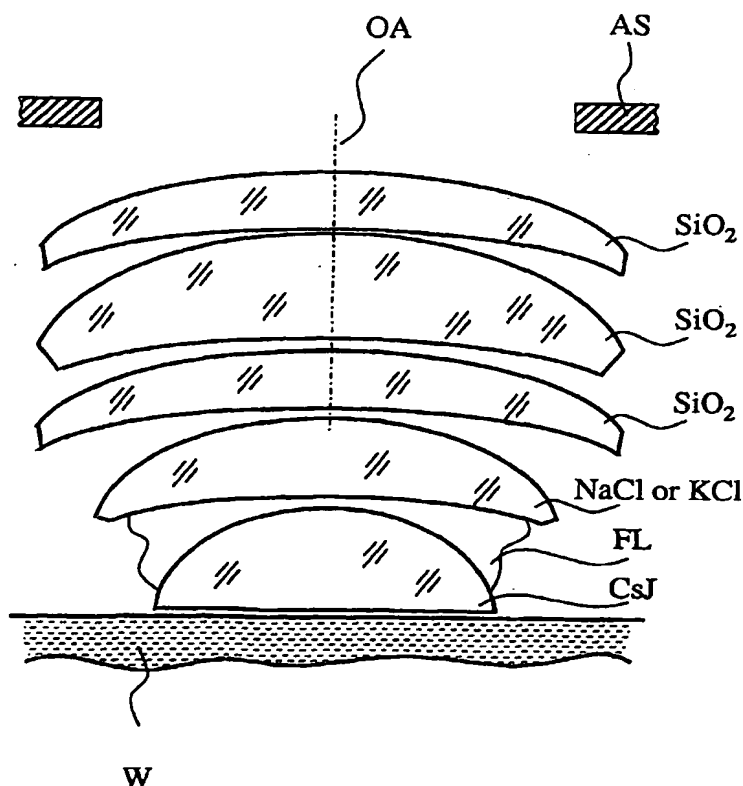
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[Continued on next page]

(54) Title: MICROLITHOGRAPHY PROJECTION OBJECTIVE WITH CRYSTAL LENSES



(57) Abstract: Very high aperture microlithography projection objectives operating at the wavelengths of 248 nm, 193 nm and also 157 nm, suitable for optical immersion or near-field operation with aperture values that can exceed 1.4 are made feasible with crystalline lenses and crystalline end plates P of NaCl, KCl, KI, RbI, CsI, and MgO, YAG with refractive indices up to and above 2.0. These crystalline lenses and end plates are placed between the system aperture stop AS and the wafer W, preferably as the last lenses on the image side of the objective.

**Declarations under Rule 4.17:**

- as to applicant's entitlement to apply for and be granted a patent (Rule 4.17(ii)) for the following designations AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BW, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NA, NI, NO, NZ, OM, PG, PH, PL, PT, RO, RU, SC, SD, SE, SG, SK, SL, SM, SY, TJ, TM, TN, TR, TT, TZ, UA, UG, UZ, VC, VN, YU, ZA, ZM, ZW, ARIPO patent (BW, GH, GM, KE, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HU, IE, IS, IT, LT, LU, MC, NL, PL, PT, RO, SE, SI, SK, TR), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG)

- as to the applicant's entitlement to claim the priority of the earlier application (Rule 4.17(iii)) for all designations
— of inventorship (Rule 4.17(iv)) for US only

Published:

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For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

INTERNATIONAL SEARCH REPORT

PCT/EP2004/014290

A. CLASSIFICATION OF SUBJECT MATTER

IPC 7 G03F7/20

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC 7 G03F

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

EPO-Internal, INSPEC, PAJ

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	US 2003/174408 A1 (ROSTALSKI HANS-JUERGEN ET AL) 18 September 2003 (2003-09-18)	1-10
X	paragraphs [0025], [0036]; figure 3; table 5	13,14
P,Y	----- JOHN H. BURNETT ET AL.: "High Index Materials for 193nm and 157nm Immersion Lithography" INTERNATIONAL SEMATECH, 2 August 2004 (2004-08-02), XP001207229 International Symposium on Immersion & 157 nm Lithography, Vancouver cited in the application the whole document	1-10
X	----- US 2002/102497 A1 (SPARROW ROBERT W) 1 August 2002 (2002-08-01) paragraph [0010] ----- -/--	13,14

☒ Further documents are listed in the continuation of box C.☒ Patent family members are listed in annex.

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- "&" document member of the same patent family

Date of the actual completion of the international search

5 August 2005

Date of mailing of the international search report

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INTERNATIONAL SEARCH REPORT

PCT/EP2004/014290

C.(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	US 4 861 148 A (SATO ET AL) 29 August 1989 (1989-08-29) column 1, line 59 -----	1
Y	US 6 025 115 A (KOMATSU ET AL) 15 February 2000 (2000-02-15) column 32, line 51 -----	1
A	EP 0 475 020 A (INTERNATIONAL BUSINESS MACHINES CORPORATION) 18 March 1992 (1992-03-18) page 4, line 57 -----	1

INTERNATIONAL SEARCH REPORT

International application No.
PCT/EP2004/014290

Box II Observations where certain claims were found unsearchable (Continuation of item 2 of first sheet)

This International Search Report has not been established in respect of certain claims under Article 17(2)(a) for the following reasons:

1. ☐ Claims Nos.:
because they relate to subject matter not required to be searched by this Authority, namely:
2. ☐ Claims Nos.:
because they relate to parts of the International Application that do not comply with the prescribed requirements to such an extent that no meaningful International Search can be carried out, specifically:
3. ☐ Claims Nos.:
because they are dependent claims and are not drafted in accordance with the second and third sentences of Rule 6.4(a).

Box III Observations where unity of invention is lacking (Continuation of item 3 of first sheet)

This International Searching Authority found multiple inventions in this International application, as follows:

see additional sheet

1. ☐ As all required additional search fees were timely paid by the applicant, this International Search Report covers all searchable claims.
2. ☐ As all searchable claims could be searched without effort justifying an additional fee, this Authority did not invite payment of any additional fee.
3. ☐ As only some of the required additional search fees were timely paid by the applicant, this International Search Report covers only those claims for which fees were paid, specifically claims Nos.:
4. ☒ No required additional search fees were timely paid by the applicant. Consequently, this International Search Report is restricted to the invention first mentioned in the claims; it is covered by claims Nos.:

1-10, 13, 14

Remark on Protest

- ☐ The additional search fees were accompanied by the applicant's protest.
- ☐ No protest accompanied the payment of additional search fees.

FURTHER INFORMATION CONTINUED FROM PCT/ISA/ 210

This International Searching Authority found multiple (groups of) inventions in this international application, as follows:

1. claims: 1-10, 13, 14

prior art: Microlithography projection objective with a numerical aperture larger than 1 and with a lens made from different crystals

special technical feature: Microlithography projection objective with a lens of crystal materials made from NaCl, KCl, KI, NaI, RbI, CsI, MgO, MgAl₂O₄ or Y₃Al₅O₃.

problem solved by these technical features:

high refraction index material increases the numerical aperture of the objective

2. claims: 11, 12

special technical feature:

end plate of a microlithography projection objective made from crystalline magnesium oxide.

problem solved by these technical features:

protection plate for other optical elements

INTERNATIONAL SEARCH REPORT

PCT/EP2004/014290

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